| Washin<br>Sir:   | r: HIROHIDE  | TENTS  1  filing is the patent applicat ENAMI et al ELASTOMER COMPOSIT   |                | OR SLUSH MOLDING & | SKIN FORM   | THE COLOR OF PTO 10/25/01 |  |  |  |
|--|--|--|----------------|--------------------|-------------|---------------------------|--|--|--|
| Enclosed are:  |  |  |                |                    |             |                           |  |  |  |
|  | An assignment of<br>A certified copy of<br>An associate pow<br>Small Entity State<br>Information   | ver of attorney.<br>us: Applicant claims small<br>Disclosure Statemen  | entity status. |                    |             | application.              |  |  |  |
| The filin  | ng fee has been ca   | lculated as shown below:<br>(Col. 1)   | (Col. 2)       | SMALL ENTITY       |             | OTHER THAN A              |  |  |  |
| FOR:   |  | NO. FILED  |                |                    |             | SMALL ENTITY              |  |  |  |
| BASIC  | ·  | NO. FILED  | NO. EXTRA      | RATE FEE           |             | RATE FEE                  |  |  |  |
| i de la comita   | L CLAIMS   | 100 - 20 =   | *              | \$ 370             |             | \$ 740                    |  |  |  |
| - Inches   | P. CLAIMS  | 100  | * 89           | x 9 =              | -  -  -     | × 18 = 1602               |  |  |  |
| 200  |  | 2 -3 =   | 0              | x 42 =             |             | x 84 = 280                |  |  |  |
| 200  |  | CLAIM PRESENTED  |                | +140 =             | OR +        | -280 = 200                |  |  |  |
| *If the  | difference in Col. 1   | is less than zero, enter 0 in Co   | ol. 2.         | TOTAL              | <u>OR</u> T | OTAL 2622                 |  |  |  |
|  | Please charge my Deposit Account No. 23-0785 amount of \$ A duplicate copy of this sheet in the copy of this sheet in the copy of th       |  |                |                    |             |                           |  |  |  |
|  |  |  |                |                    |             |                           |  |  |  |
| A check in the amount of \$\frac{2622.00}{}\$ to cover the filing fee is enclosed.  The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account No. 23-0785. A duplicate copy of this sheet is enclosed. |  |  |                |                    |             |                           |  |  |  |
| Section 1  |  | itional filing fees required u<br>ent application processing t   |                |                    |             |                           |  |  |  |
| •  |  |  |                |                    |             |                           |  |  |  |
| Any patent application processing fees under 37 CFR 1.17.  The issue fee set in 37 CFR 1.18 at or before mailing of the Notice of Allowance, pursuant to 37 CFR 1.311(b).  Any filing fees under 37 CFR 1.16 for presentation of extra claims.   |  |  |                |                    |             |                           |  |  |  |
| Respectfully submitted, CERTIFICATE OF MAILING BY "EXPRESS MAIL"   |  |  |                |                    |             |                           |  |  |  |
| "Express  <br>Date of De   | Mail" mailing label num<br>eposit <u>10 – 3</u>  | ber EM258140673  |                |                    | 1           |                           |  |  |  |
| States Pounder 37  | ostal Service "Express<br>CFR 1.10 on the date<br>Commissioner for Pate  | or fee is being deposited with the<br>Mail Post Office to Addressee"<br>indicated above and is addresse<br>ents, Washington, D.C. 20231. | service        | S. Mortimer, Reg.  | No. 30,40   | 7                         |  |  |  |
|  |  | e of person mailing paper or fee)  |                |                    |             |                           |  |  |  |
| C  | The state of the s | LAUN D   |                |                    |             |                           |  |  |  |
|  | (Signature of pe   | rson mailing paper or fee)   |                |                    |             |                           |  |  |  |

This application claims the priority of Japanese Application Nos. 331886/2000 filed October 31, 2000, 51764/2001 filed February 27, 2001, and 192147/2001 filed June 26, 2001.

Any additional costs incurred with regard to this matter should be charged to our Deposit Account No. 23-0785.

A filing date based on the filing of these papers under 37 CFR Section 1.10(a) is respectfully requested.

Respectfully submitted,

John S. Mortimer Reg. No. 30,407

WOOD, PHILLIPS, VANSANTEN, CLARK & MORTIMER 500 W. Madison Street, Suite 3800 Chicago, IL 60661 (312) 876-1800

Oct 26\_\_\_,2001

01-25-02

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

| Application of:      | ) | THERMOPLASTIC ELASTOMER COMP                             |
|----------------------|---|--|
| HIROHIDE ENAMI et al |   | SITION FOR A POWDER FOR SLUSH<br>MOLDING AND SKIN FORMED |
| Ser. No.: Unassigned | ) | THEREFROM  |
| Filed: Herewith      | ) |  |

## TRANSMITTAL LETTER

Assistant Commissioner for Patents Washington, D.C. 20231 Sir:

Enclosed herewith for filing under 37 C.F.R. Section 1.53(b) is a patent application, including:

- 1) A Specification and claims for the patent application of HIROHIDE ENAMI, KENROU ONO, KENJI KUBOMOTO, AND YOSHIHIRO TODA, entitled "THERMOPLASTIC ELASTOMER COMPOSITION FOR A POWDER FOR SLUSH MOLDING AND SKIN FORMED THEREFROM";
- 2) 1 sheet of formal drawings;
- 3) A check in the amount of \$2622.00 for the filing fee;
- 4) Computation sheet form PTO-1082;
- Information Disclosure Statement and 4 References; and 5)
- 6) Certificate of Mailing by "Express Mail" No. EM258140673 dated /0 - ⊃ (6 - 0 )

CERTIFICATE OF MAILING BY "EXPRESS MAIL" "Express Mail" mailing label No. FH258/40673
Dated 10-26-01 - I hereby certify that this paper or fee is being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 CFR 1.10 on the date indicated above and is addressed to the Assistant Commissioner for Patents, Washington, DC 20231.

(Terri Craine)